



# G1DQ

SOD-123FL Rectifier Diode  
SOD-123FL 整流二极管

## 1. Description 描述

The rectifier diode encapsulated in a small SOD-123FL Surface-Mounted Device (SMD) plastic package.

这种整流二极管采用小型 SOD-123FL 表面贴装 (SMD) 塑料封装。

## 2. Features 特性

Feature 特性	Description 描述
Low Forward Voltage 低正向电压	$V_F < 1.1V @ I_F = 1A$
Low Reverse Leakage Current 低反向漏电流	$I_R < 5\mu A$
Applications 应用	For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive and telecommunication. 适用于消费电子、汽车和通信领域中的电源、逆变器、转换器和续流二极管的通用整流。
Environmental Compliance 环保合规	<ul style="list-style-type: none"><li>Totally Lead-Free &amp; Fully RoHS Compliant. 完全无铅和符合 RoHS 标准<sup>[1]</sup></li><li>Halogen and Antimony Free, "Green" Device. 无卤素和无锑, "绿色"器件<sup>[2]</sup></li></ul>
Automotive Compliance 汽车合规	Qualified according to AEC-Q101 and recommended for use in automotive applications. 通过了 AEC-Q101 认证, 推荐用于汽车电子应用场景。

[1] No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

无铅, 完全符合欧盟标准 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) 和 2015/863/EU (RoHS 3)。

[2] Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

无卤素和无锑的“绿色”产品指溴含量<900ppm, 氯含量<900ppm (溴+氯总含量<1500ppm) 和锑化合物含量<1000ppm。

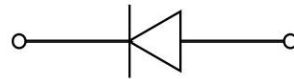


### 3. Mechanical Data 封装数据

Feature 特性	Description 描述
Package 封装	SOD-123FL
Moisture Sensitivity Level 湿敏感度等级	J-STD-020 MSL1
Material 材料	Molded Plastic, “Green” Molding Compound; UL Flammability Classification Rating 94V-0. 模塑塑料封装，“绿色”成型复合材料；UL 易燃等级 94V-0。
Dimensions 尺寸	3mm × 1.9mm × 1mm body 封装本体（不含引脚）尺寸为 3mm × 1.9mm × 1mm
Terminals Compliance 引脚合规	2 terminals, Tin Plated Leads, Solderable per MILSTD-202, Method 208②③ 2 个镀锡引脚，可焊性符合 MIL-STD-202 标准中 208 方法 e3 条款的要求
Weight 重量	0.0169 grams (Approximate) 约 0.0169 克
Polarity 极性	See Diagrams Below 具体极性见下图



SOD-123FL Top View



Device Symbol

### 4. Ordering Information 订购信息

Part Number	Compliance	Package	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
G1DQ	Automotive	SOD-123FL	7	8	3000

### 5. Marking Information 丝印信息

Part Number	Marking Code
G1DQ	G1D



## 6. Absolute Maximum Ratings( $T_a = + 25^{\circ}\text{C}$ ) 绝对最大额定值

Characteristic 特性	Symbol 符号	Value 值	Unit 单位
Repetitive Peak Reverse Voltage 重复峰值反向电压	$V_{RRM}$	1000	V
DC Reverse Voltage 直流反向电压	$V_R$	1000	V
RMS Reverse Voltage 反向电压均方根值	$V_{R(RMS)}$	700	V
Forward Rectified Current 正向整流电流	$I_F$	1	A
Peak Surge Current 峰值浪涌电流	$I_{FSM}$	25	A

## 7. Thermal Characteristics( $T_a = + 25^{\circ}\text{C}$ ) 热特性

Characteristic 特性	Symbol 符号	Value 值	Unit 单位
Thermal Resistance From Junction To Ambient 结到环境的热阻	$R_{\theta JA}$	80	$^{\circ}\text{C}/\text{W}$
Junction Temperature 结温	$T_J$	-55 ~ +150	$^{\circ}\text{C}$
Storage Temperature 储藏温	$T_{stg}$	-55 ~ +150	$^{\circ}\text{C}$

## 8. Electrical Characteristics( $T_a = + 25^{\circ}\text{C}$ ) 电特性

Characteristic 特性	Symbol 符号	Min. 最小值	Typ. 典型值	Max. 最大值	Unit 单位	Conditions 条件
Reverse Leakage Current 反向漏电流	$I_R$	-	-	5	$\mu\text{A}$	$V_R = V_{RRM}$
Forward Voltage 正向电压	$V_F$	-	1.0	1.1	V	$I_F = 1\text{A}$
Diode Capacitance 二极管电容	$C_D$	-	15	-	pF	$V_R = 4\text{V}, f = 1\text{MHz}$



### 9. Typical Electrical Characteristics Curve 典型电特性曲线

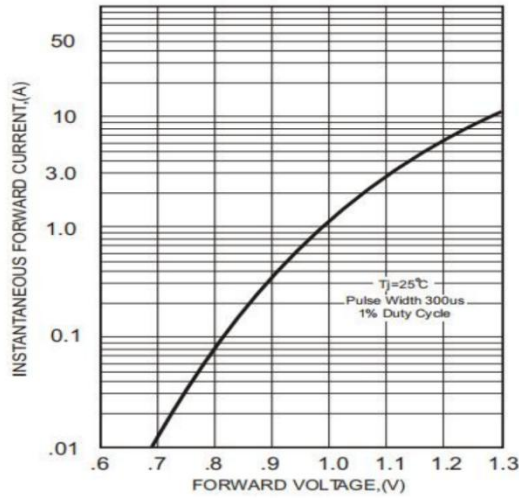


Figure 1: Forward Characteristics

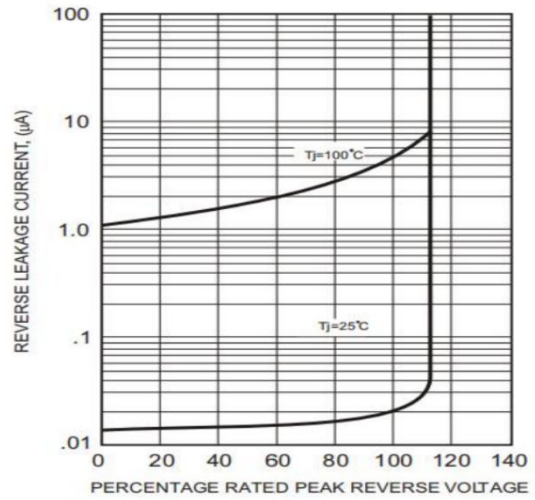


Figure 2: Reverse Characteristics

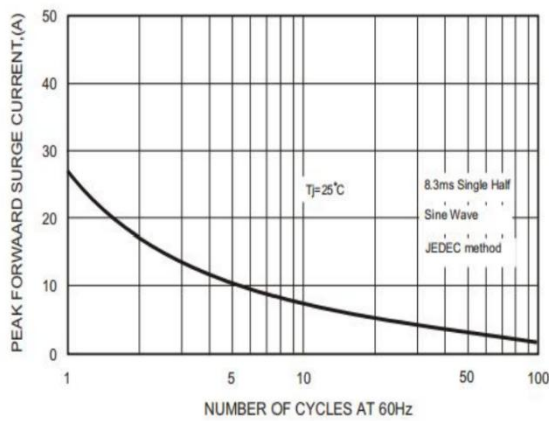


Figure 3: Surge Current Characteristics

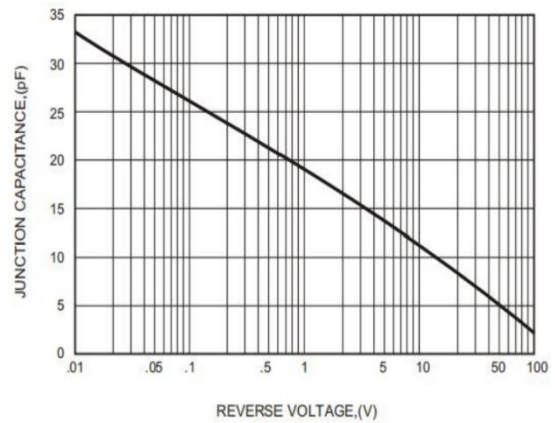


Figure 4: Junction Capacitance

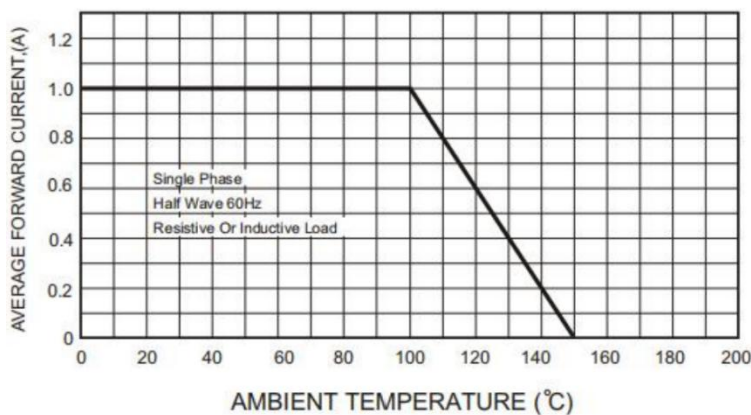
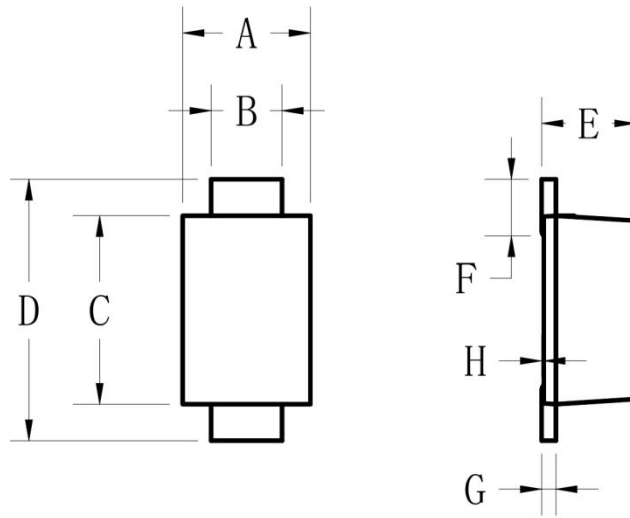


Figure 5: Forward Current Derating

## 10. Package Outline Dimensions 封装外形尺寸

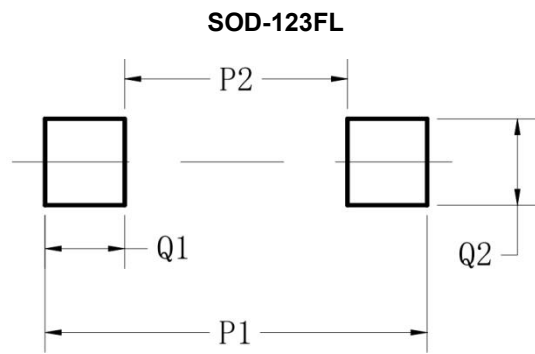
SOD-123FL



Symbol 符号	Millimeters 毫米	
	Min.最小值	Max.最大值
<b>A</b>	1.75	1.95
<b>B</b>	0.80	1.10
<b>C</b>	2.60	2.90
<b>D</b>	3.55	3.75
<b>E</b>	0.95	1.15
<b>F</b>	0.55	0.85
<b>G</b>	0.12	0.20
<b>H</b>	0.02	0.05



### 11. Suggested Pad Layout 推荐焊盘布局



Dimensions 尺寸	Millimeters 毫米
P1	3.90
P2	1.90
Q1	1.00
Q2	1.50

Fig. Soldering footprint for SOD-123FL

图 SOD-123FL 的引脚焊接



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